

# **SPECIFICATION**

Part No. : **DBP.868.U.A.30** 

Description : Dielectric Band Pass Filter for 868MHz

Bandwidth 4MHz

Features : Center Frequency 868MHz

Supports European ISM Radio Applications

Low Insertion Loss

Low Pass-Band Ripple

High Ultimate Attenuation

Dims: 9.0\*7.3\*3.7mm







### 1. Introduction

Taoglas are utilizing their deep understanding of the RF component design and manufacturing process to provide high-quality, small-form-factor, cost-effective and easy to implement RF filters. The Taoglas Filters Division will feature a range of off-the-shelf filters for a variety of applications, including filters for emerging license free bands used for IoT and for GPS L1/L2 and L1/L5 applications. We can also work with customers to develop bespoke filter solutions.

Taoglas dielectric filters are designed to be used in wireless transmitters or receivers. These filters are designed to protect the LNA from noisy out of band emissions originated from nearby transmitters that can overdrive, or even damage your LNA. Overdriving the LNA results in non-linear distortion which negatively impacts the sensitivity of your receiver.

By selecting the proper Taoglas filter you can eliminate unnecessary out of band noise while maintaining minimal in-band insertion loss. The filter is manufactured as a single ceramic block [monoblock] which provides high reliability, low insertion loss and high attenuation in a simple compact SMD package.

The DBP.868.U.A.30 is a standard Taoglas product but can be customized for specific customer needs. For more information please contact your regional sales office.



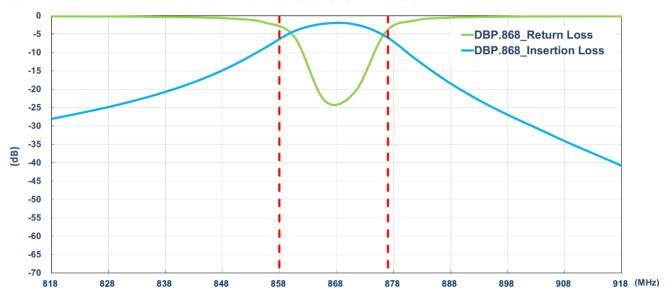
# 2. Specification

ELECTRICAL				
Centre Frequency (Fo)	868MHz			
3dB Bandwidth	4MHz			
Insertion Loss	3.0 dB max			
Passband Ripple	0.5 dB max			
Return Loss	< -10 dB			
	> 30.0 dB@ 0 ~ 800 MHz			
Attenuation	> 24.0 dB @ 800 MHz ~ 824 MHz			
	> 30.0 dB@ 912 MHz ~ 950 MHz			
	> 45.0 dB @ 950 MHz ~ 2 GHz			
In/Out Impedance	<b>50</b> Ω			
Power Dissipation	1.0 W min.			
MECHANICAL				
Dimension	Dimension 9.0*7.3*3.7mm (L x W x H)			
Material	Ceramic			
Finish	Ag plated			
ENVIRONMENTAL				
Operating Temperature	-40°C to 85°C			
Storage Temperature	-40°C to 85°C			

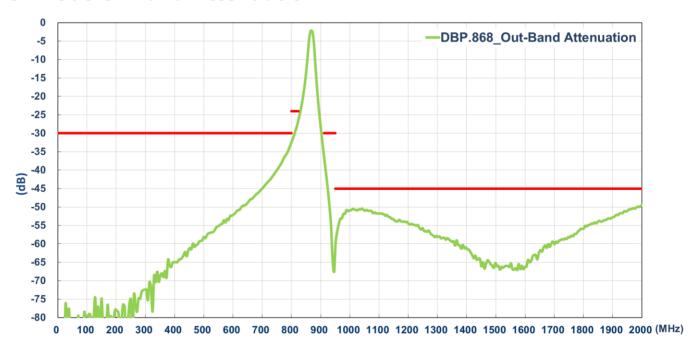


# 3. Characteristics Curve

#### 3.1. Pass Band Return & Insertion Loss



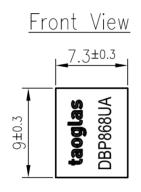
#### 3.2. Out-Of-Band Attenuation

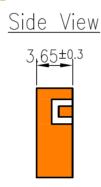


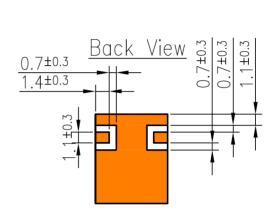


# 4. Mechanical Drawings (Unit: mm)

# 4.1. Antenna Drawing



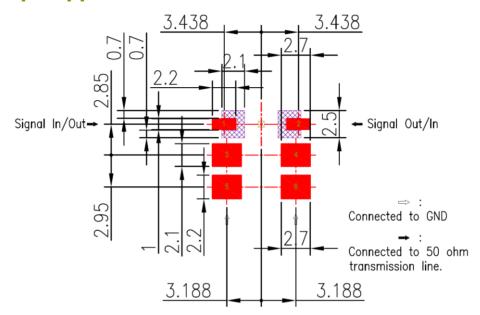




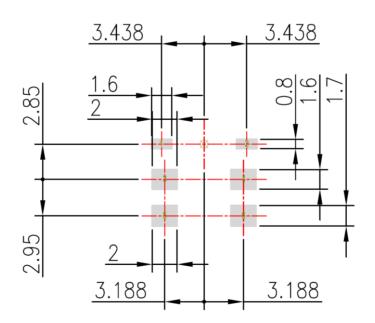


#### 4.2. Recommended PCB Layout

#### 4.2.1. Top Copper



### 4.2.2. Top Solder Paste

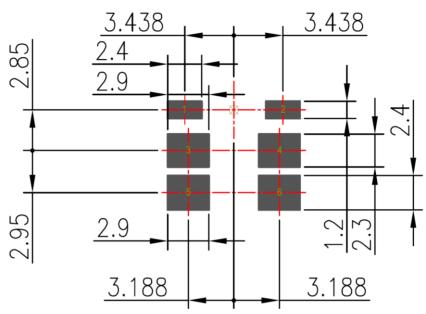


#### NOTE:

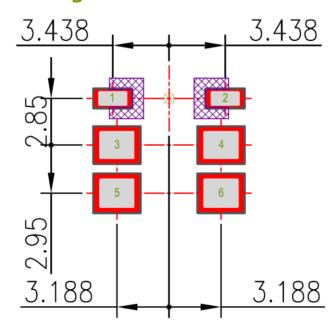
- 1. Ag Plated area
- 2. Solder Mask area
- 3. Copper area
- 4. Paste area
- 5. Copper Keepout Area
- 6. Any vias in pads should be either filled or tented to prevent solder from wicking away from the pad during reflow.7. The dimension tolerances should follow standard PCB manufacturing
- 7. The dimension tolerances should follow standard PCB manufacturing quidelines



# 4.2.3. Top Solder Mask



### 4.2.4. Composite Diagram



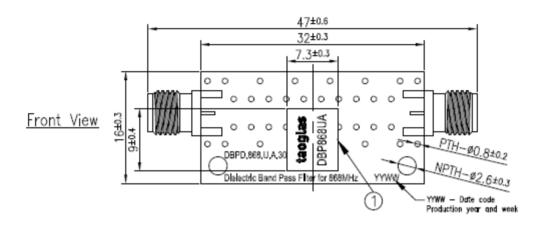
#### NOTE:

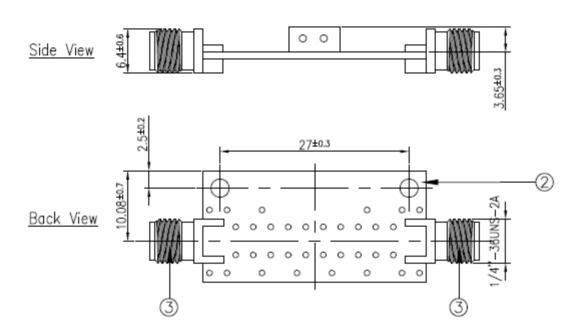
- 1. Ag Plated area
- 2. Solder Mask area
- 3. Copper area
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  7. The dimension telepropes should follow standard PCR manufacturing.
- 7. The dimension tolerances should follow standard PCB manufacturing quidelines



#### 4.3. Evaluation Board





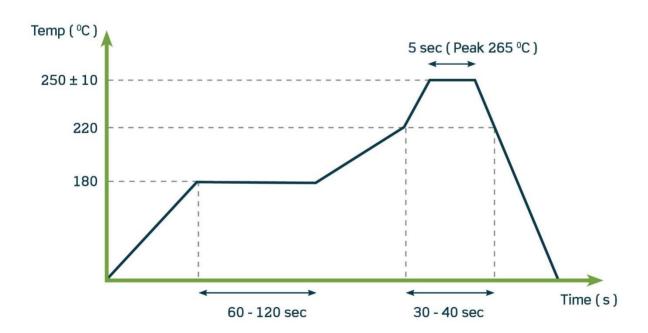
NOTE: 1.All material must be RoHS compliant.

L		Name	Material	Finish	QTY
Г	1	Filter	Ceramic	Clear	1
	2	PCB	Composite 1.0t	Black	1
	3	SMA(F) ST	Brass	Au Plated	2



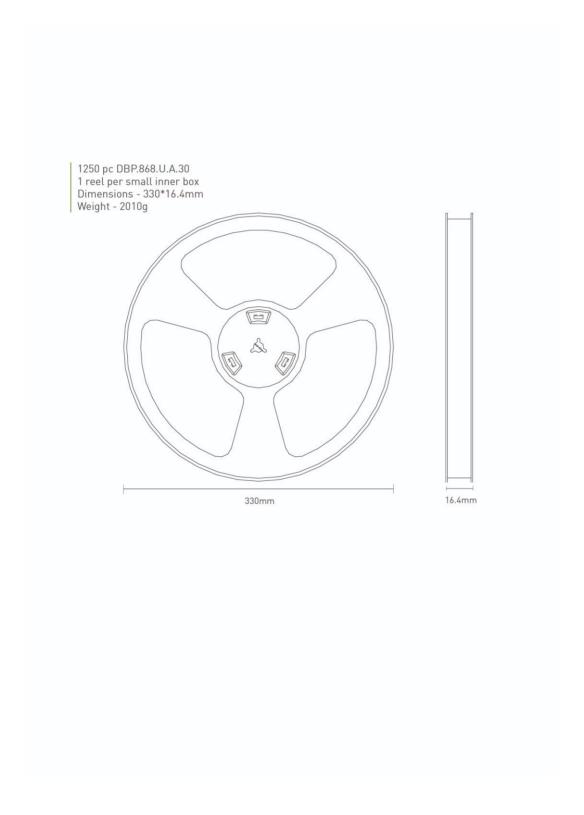
# **5. Recommended Reflow Soldering Profile**

Phase	Profile Features	Maximum
	Temperature Min	150 °C
Preheat	Temperature Max	180 °C
	Duration	60-120 sec
Ramp-Up	Avg. Ramp up rate	3 °C/sec (max)
Dofford	Temperature	220 °C
Reflow	Duration	30-40 sec
Dools	Temperature	265 °C
Peak	Duration	5 sec Max
Ramp Down	Avg. Ramp down rate	3 °C/sec (max)



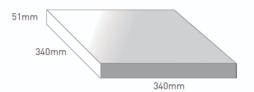


# 6. Recommended Reflow Soldering Profile

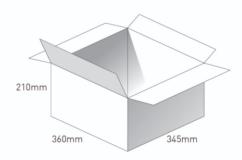




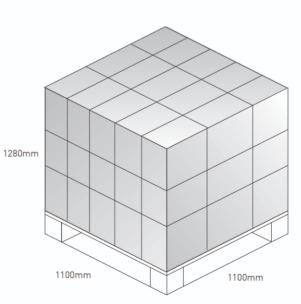
2500 pc DBP.868.U.A.30 2 reel in small inner box Dimensions - 340\*340\*51 Weight - 4.14Kg



4 inner boxes / 10000 pcs in one carton Carton Dimensions - 210\*345\*360mm Weight -17.1Kg



Pallet Dimensions 1100\*1100\*1280mm 24 Cartons per Pallet 6 Cartons per layer 4 Layers





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